



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

A.N. H.I
Rce. 10/11/05
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In re Applicant:

Salman Akram

Serial No.: 09/853,111

Filed: May 10, 2001

For: Method of Fabricating Mounted
Multiple Semiconductor Dies
In a Package (As Amended)

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Art Unit: 2827

Examiner: Alonzo Chambliss

Atty Docket: MCT.0012D1US
97-0141.02

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to the receipt of an office action, please amend the above-referenced patent application as follows:

Date of Deposit: October 6, 2005

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Cynthia L. Hayden
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